April 2013



FGH25N120FTDS 1200 V, 25 A Field Stop Trench IGBT

Features

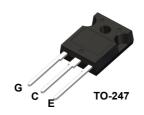
- · High Speed Switching
- Low Saturation Voltage: V_{CE(sat)} = 1.60 V @ I_C = 25 A
- High Input Impedance
- RoHS Compliant

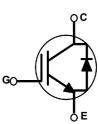
Applications

• Solar Inverter, UPS, Welder, PFC

General Description

Using advanced field stop trench technology, Fairchild®'s 1200V trench IGBTs offer the optimum performance for hard switching application such as solar inverter, UPS, welder and PFC applications.





Absolute Maximum Ratings

Symbol	Description		Ratings	Unit
V _{CES}	Collector to Emitter Voltage		1200	V
V _{GES}	Gate to Emitter Voltage		± 25	V
L	Collector Current	@ T _C = 25°C	50	А
IC	Collector Current	@ T _C = 100°C	25	А
I _{CM (1)}	Pulsed Collector Current		75	А
I _F	Diode Continuous Forward Current	@ T _C = 100 ^o C	25	A
I _{FM}	Diode Maximum Forward Current		75	А
P _D	Maximum Power Dissipation	@ T _C = 25 ^o C	313	W
	Maximum Power Dissipation	@ T _C = 100°C	125	W
TJ	Operating Junction Temperature		-55 to +150	°C
T _{stg}	Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

Notes: 1: Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction to Case	-	0.4	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	-	1.25	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W

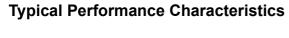
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FGH25N120FTDS	FGH25N120FTDS	TO-247	-	-	30

Electrical Characteristics of the IGBT $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics					
BV _{CES}	Collector to Emitter Breakdown Voltage	V _{GE} = 0V, I _C = 250μA	1200	-	-	V
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$	-	-	1	mA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$	-	-	±250	nA
On Charac	teristics					
V _{GE(th)}	G-E Threshold Voltage	I _C = 25mA, V _{CE} = V _{GE}	3.5	6	7.5	V
		I _C = 25A, V _{GE} = 15V	-	1.6	2	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	$I_{\rm C}$ = 25A, $V_{\rm GE}$ = 15V, $T_{\rm C}$ = 125°C	-	1.92	-	V
Dynamic C	haracteristics					
C _{ies}	Input Capacitance		-	4090	-	pF
C _{oes}	Output Capacitance	$V_{CE} = 30V, V_{GE} = 0V,$	-	135	-	pF
C _{res}	Reverse Transfer Capacitance	f = 1MHz	-	75	-	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time	_	-	26	35	ns
t _r	Rise Time		-	41	53	ns
t _{d(off)}	Turn-Off Delay Time	$V_{\rm CC}$ = 600V, I _C = 25A,	-	151	196	ns
t _f	Fall Time	$R_G = 10\Omega$, V _{GE} = 15V, Inductive Load, T _C = 25 ^o C	-	102	132	ns
Eon	Turn-On Switching Loss		-	1.42	1.84	mJ
E _{off}	Turn-Off Switching Loss		-	1.16	1.5	mJ
E _{ts}	Total Switching Loss		-	2.58	3.34	mJ
t _{d(on)}	Turn-On Delay Time		-	22	-	ns
t _r	Rise Time		-	41	-	ns
t _{d(off)}	Turn-Off Delay Time	V _{CC} = 600V, I _C = 25A,	-	163	-	ns
t _f	Fall Time	$R_{G} = 10\Omega, V_{GE} = 15V,$	-	136	-	ns
Eon	Turn-On Switching Loss	Inductive Load, T _C = 125 ^o C	-	2.04	-	mJ
E _{off}	Turn-Off Switching Loss		-	1.58	-	mJ
E _{ts}	Total Switching Loss		-	3.62	-	mJ
Qg	Total Gate Charge		-	169	225	nC
Q _{ge}	Gate to Emitter Charge	V _{CE} = 600V, I _C = 25A, V _{GE} = 15V	-	33	44	nC
Q _{gc}	Gate to Collector Charge	• GE - 15 V	-	78	104	nC

Symbol	Parameter	Test Conc	Min.	Тур.	Мах	Unit	
V _{FM}	Diode Forward Voltage	I _F = 25A	T _C = 25°C	-	2.5	3.5	V
		1F - 20A	$T_{\rm C} = 125^{\rm o}{\rm C}$	-	2.3	-	
t _{rr} D	Diode Reverse Recovery Time	I _{ES} = 25A, di/dt = 200A/μs	T _C = 25°C	-	411	535	ns
			T _C = 125 ^o C	-	496	-	
l	Diode Peak Reverse Recovery Current		$T_{\rm C}$ = 25°C	-	5.2	6.8	А
'rr			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	6.9	-] ^`
Q _{rr}	Diode Reverse Recovery Charge		T _C = 25 ^o C	-	1.1	1.82	μC
≪II.	Diede Reference Receivery enalge		T _C = 125 ^o C	-	1.7	-	μΟ





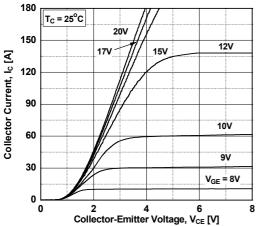


Figure 3. Typical Saturation Voltage Characteristics

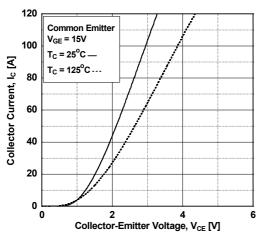


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

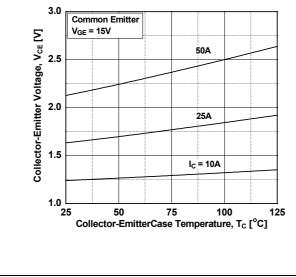


Figure 2. Typical Output Characteristics

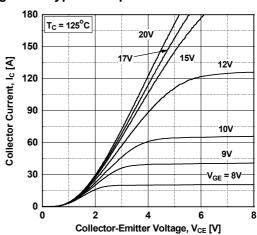


Figure 4. Transfer Characteristics

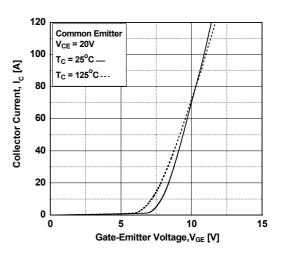
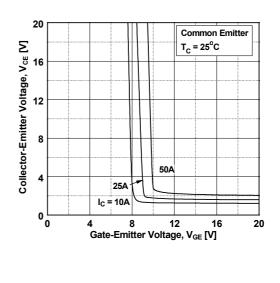
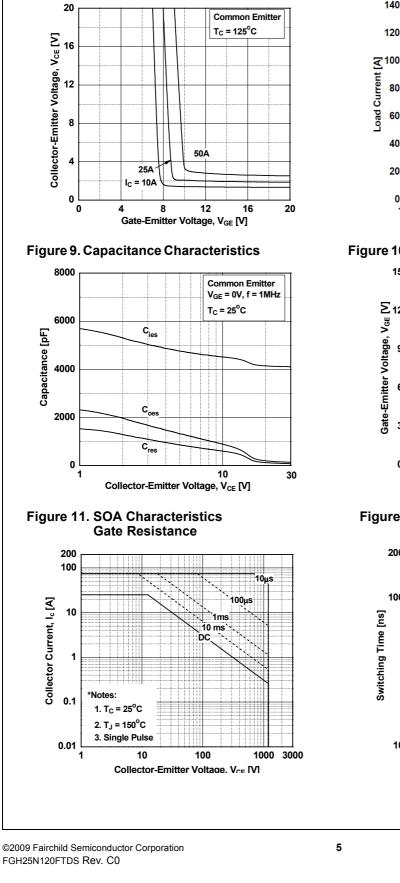


Figure 6. Saturation Voltage vs. V_{GE}



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Typical Performance Characteristics

Figure 7. Saturation Voltage vs. V_{GE}

Figure 8. Load Current vs. Frequency

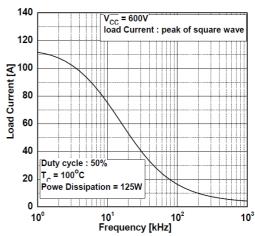


Figure 10. Gate Charge Characteristics

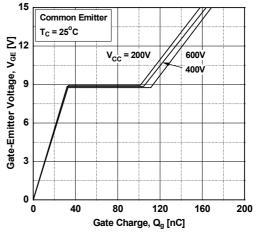
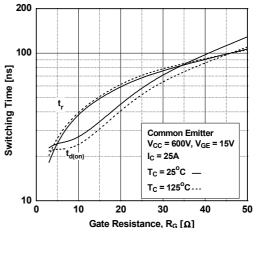


Figure 12. Turn-on Characteristics vs. **Gate Resistance**



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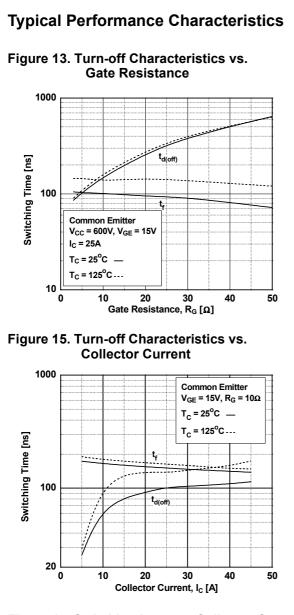


Figure 17. Switching Loss vs. Collector Current

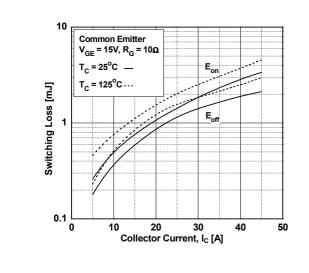


Figure 14. Turn-on Characteristics vs. Collector Current

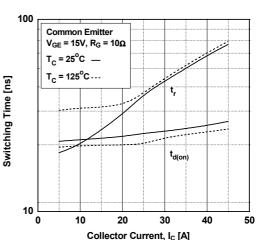


Figure 16. Switching Loss vs. Gate Resistance

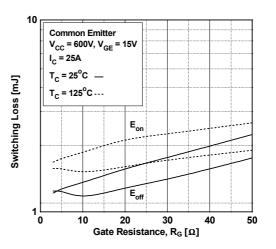
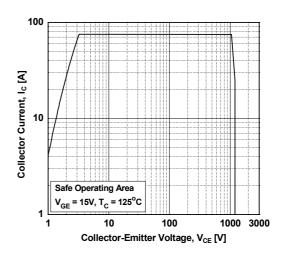
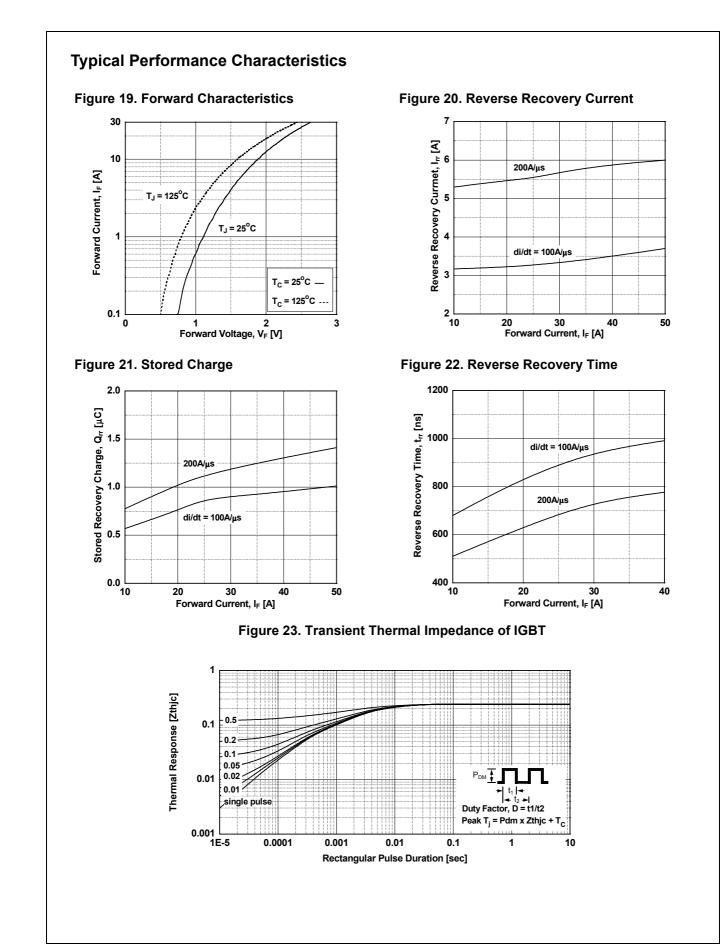


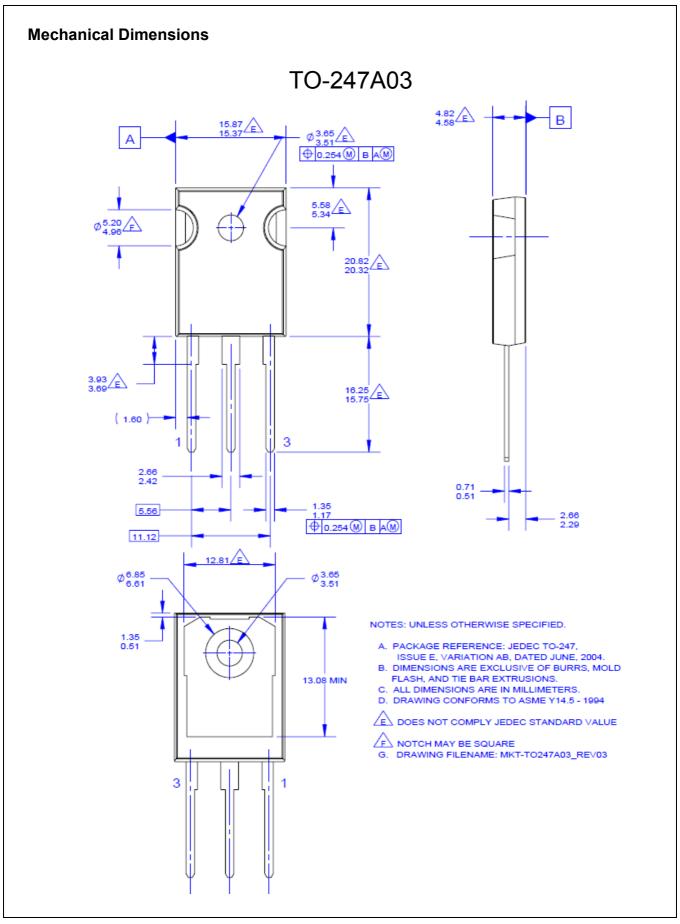
Figure 18. Turn off Switing SOA Characteristics



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